Jun. 23, 2023 Listing Department Tokyo Stock Exchange, Inc.

## Outline of Initial Listing Issue

Company Name Qualtec Co.,Ltd. Scheduled Listing Date Jul. 28, 2023 Market Section Growth Market

Current Listed Market N/A

Name and Title of

YAMAGUCHI Tomohiro, President Representative

Address of Main Office 4-230 Sanbo-cho, Sakai-ku Sakai-shi, Osaka, 590-0906

Tel. +81-72-226-7175

(Closest Point of Contact)

(Same as above) Home Page https://www.qualtec.co.jp/

Date of Incorporation Jan. 18, 1993

Description of Business Provides failure analysis and reliability testing of electronic

components

Microfabrication centered on laser processing and surface treatment

(plating) technologies. etc.

Category of Industry /

Servicies / 9165 (ISIN JP3266010002)

Authorized Total No. of

Shares to be Issued

8,400,000 shares

No. of Issued Shares

2,100,000 shares (As of Jun. 23, 2023)

No. of Issued Shares

2,350,000 shares

(incl. treasury shares) at the Time of Listing (Note) The number includes newly issued shares issued through the public offering.

JPY 100,000 thousand (As of Jun. 23, 2023) Capital

No. of Shares per Share

100 shares

Unit

**Business Year** From Jul. 1 to Jun. 30 of the following year

Sumitomo Mitsui Trust Bank, Limited

General Shareholders

Within 3 months after the end of the business year

Meeting

Record Date Jun. 30

Record Date of Surplus

Dec. 31 and Jun. 30

Dividend

Transfer Agent

Auditor

KPMG AZSA LLC

**Managing Trading** 

**Participant** 

Nomura Securities Co.,Ltd.

Overview of Public Offering	g / Secondary Offering >	
Public Offering /	Public Offering (Newly Issued Shares)	250,000 shares
Secondary Offering	Secondary Offering	955,000 shares
	(Placement Underwritten and Purchased	
	by Principal Underwriting Participants)	
	Secondary Offering	180,700 shares
	(Placement by over-allotment scheme)	
Original Share Offerers	Rising Japan Equity No.2 Investment	925,000 shares
	Limited Partnership	
	SHIKATA Hirokazu	30,000 shares
Offering Price	Book-building method	
<b>Determination Method</b>		
<b>Provisional Conditions</b>	Jul. 7, 2023	
<b>Determination Date</b>		
Book-building Period	Jul. 11, 2023 to Jul. 18, 2023	
Offering Price	Jul. 19, 2023	
<b>Determination Date</b>		
Subscription Period	Jul. 20, 2023 to Jul. 25, 2023	
Payment Date	Jul. 27, 2023	
Settlement Date	Jul. 28, 2023	
Principal Underwriting	Nomura Securities Co.,Ltd.	
Participants	SMBC Nikko Securities Inc.	
	SBI SECURITIES Co.,Ltd.	
	IwaiCosmo Securities Co.,Ltd.	
	Marusan Securities Co.,Ltd.	
	Okasan Securities Co., Ltd.	
	Kyokuto Securities Co., Ltd.	
	Monex, Inc.	

- (Note 1) Tokyo Stock Exchange, Inc. approves new listings based on the results of the examination by Japan Exchange Regulation.
- (Note 2) The "Initial Listing Application Securities Report (Part I)" (only in Japanese) of the company is available on the JPX official website. Please refer to such release for details.
- (Note 3) Buy and sell market orders for this issue are prohibited in transactions carried out up to and including the initial price determination date.